# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## CG/CG2 Series



#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER		
<b>91</b>	E1286621		
<b>91</b>	E320116 <sup>2</sup>		

NOTES: 1. Certified to UL 497B.

Certified to OE 4375.
 Only CG2300, CG2470, CG2600, CG2800 and CG221000. Certified to UL 1449.

### 2 Electrode GDT Graphical Symbol



#### Additional Information







#### Description

Littelfuse highly reliable CG/CG2 Series GDTs provide a high degree of surge protection in a small size ideal for board level circuit protection.

RoHS

(Pi) 74

GDTs function as switches which dissipate a minimum amount of energy and therefore handle currents that far surpass other types of transient voltage protection. Their gas-filled, rugged ceramic metal construction make them well suited to adverse environments.

The CG/CG2 series comes in a variety of forms including surface mount, core, straight and shaped leads, to serve a variety of mounting methods.

The CG Series (75V-110V) is ideal for protection of test and communication equipment and other devices in which low voltage limits and extremely low arc voltages are required.

The CG2 Series (145V-1000V) is ideal for protecting equipment where higher voltage limits and holdover voltages are necessary.

#### Features

- RoHS and Lead-free compliant
- Rugged Ceramic-Metal construction
  Low Capacitance
- Low Capacitance (<1.5pf)</li>
- Meets REA PE-80
- Available in surface mount, and a variety of lead options options

#### Applications

- Communication lines and equipment
- CATV equipment
- Test equipment
- Data lines
- Power supplies
- Instrumentation circuits
- Medical electronics
- ADSL equipment
- Telecom SLIC protection

# Gas Discharge Tubes CG/CG2 Series



#### **Electrical Characteristics**

	Device Specifications (at 25°C)				Life Ratings										
Part		Breakd in Volts @100V/s	S	Impulse Break- down in Volts (@100V/µs)	Impulse Break- down In Volts (@1 Kv/µsec)	Insulation Resistance	Capaci- tance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@500A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1sec @50-60Hz)	AC Dischage Current (9 cycle @50Hz)	DC Holdover Voltage <sup>2</sup>	Max Impulse Discharge Current (1 Application @ 10/350µs)	
Number	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP		
CG75	60	75	90	400	650										
CG90	72	90	108	400	600	10 <sup>10</sup> Ω (at 50V)	t 50V) 1.5 pf 15 V	15 V	400 shots	10 shots (@20kA) <sup>3</sup>	20 A	100 A	52 V	4kA	
CG90 SN	72	90	108	400	600										
CG110	88	110	132	450	600										
CG2145	116	145	174	500	600								80 V		
CG2145 SN	120	145	174	500	600										
CG22301	195	230	265	600	700										
CG2230 SN1	184	230	276	600	700								135 V	2.5kA	
CG2250	213	250	288	625	725										
CG2250 SN	200	250	300	625	725										
CG2300	255	300	345	700	800										
CG2300 SN	240	300	360	700	800	10 <sup>10</sup> Ω									
CG2350	297	350	403	750	900	(at 100V)									
CG2350 SN	280	350	420	750	900										
CG2420	357	420	483	800	1000										
CG24701	400	470	540	850	1200	-									
CG2470 SN1	376	470	564	850	1200										
CG26001	510	600	690	1000	1400										
CG2600 SN1	480	600	720	1000	1400										
CG28001	680	800	920	1200	1500					10 shots	10 A				
CG210001	850	1000	1150	1500	1600					(@10kA)		65 A			

NOTES: 1. Certified to UL 1449. 2. Reference REA PE-80, 0.2A. Tested to ITU-T Rec K.12 and REA PE 80 < 150 mSec. 5. TE (1) and institutions 20kA 8/20uSec. (75 to 600 volt devices.) 3. 5 x [5 (+) or 5 (-)] applications 20kA 8/20µSec. (75 to 600 volt devices.) 10 x [5 (+) and 5 (-)] applications 10kA 8/20µSec. (800 and 100 volt devices.)

#### **Product Characteristics**

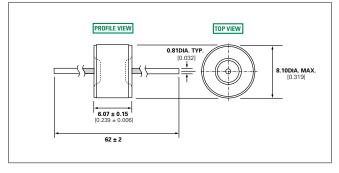
Materials	LS, Axial: Device: Tin Plated 2–5 Microns Lead Wires: Tin Plated 17.5 ± 12.5 Microns Construction: Ceramic Insulator Core: Device: Tin Plated 17.5 ± 12.5 Microns. Construction: Ceramic Insulator MS: Device: Dull Tin Plated 7–9 Microns Construction: Ceramic Insulator
Product Marking	LF Logo, Voltage and date code; Black in positive print

Glow to arc transition current	< 0.5Amps
Glow Voltage	60-160 Volts
Storage and Operational Temperature	-40 to +90
Maximum Follow On Current <sup>1</sup>	230 Volts r.m.s, 200 Amps. (800V and 1000V devices tested to UL1449 3rd edition)

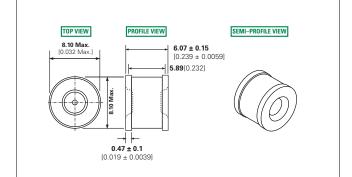


#### **Device Dimensions**

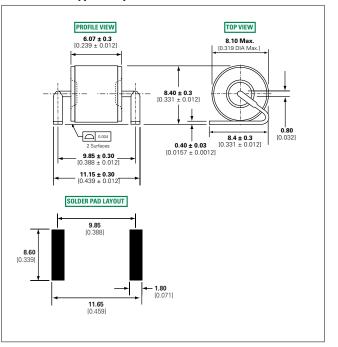
#### Leaded 'L' Type Straight Axial Devices



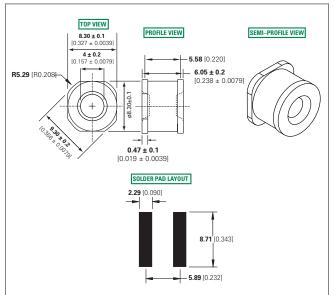
#### **Core Devices**



#### Leaded 'LS' Type Shaped Lead Devices



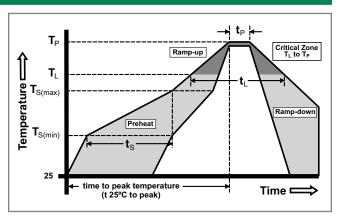
#### 'MS' Type Devices



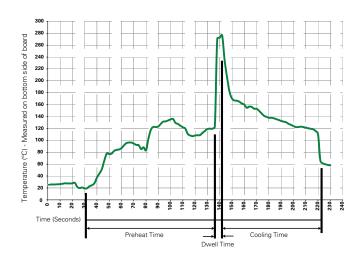


#### Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb – Free assembly		
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150°C		
	-Temperature Max (T <sub>s(max)</sub> )	200°C		
	-Time (Min to Max) (t <sub>s</sub> )	60 – 180 secs		
Average ra (T <sub>L</sub> ) to pea	amp up rate (LiquidusTemp k	3°C/second max		
T <sub>S(max)</sub> to T <sub>L</sub>	- Ramp-up Rate	5°C/second max		
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C		
	-Temperature (t <sub>L</sub> )	60 – 150 seconds		
PeakTemp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C		
Time with Temperatu	in 5°C of actual peak ıre (t <sub>p</sub> )	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max		
Time 25°C	to peakTemperature (T <sub>P</sub> )	8 minutes Max.		
Do not exc	ceed	260°C		



#### Soldering Parameters - Wave Soldering (Thru-Hole Devices)



### **Recommended Process Parameters:**

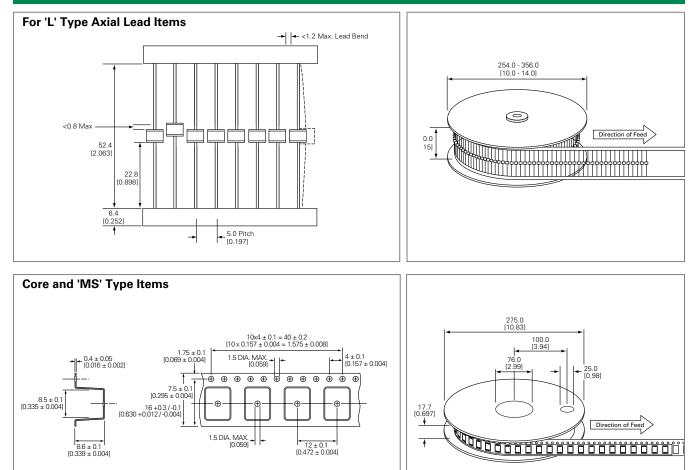
Wave Parameter	Lead-Free Recommendation		
Preheat:			
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder Dwell Time:	2-5 seconds		

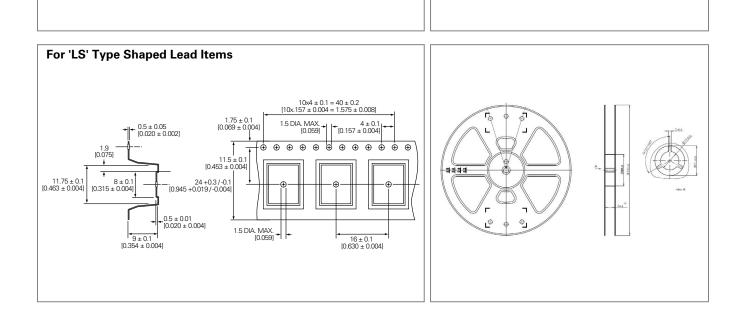
#### Soldering Parameters - Hand Soldering

Solder Iron Temperature: 350° C +/- 5°C Heating Time: 5 seconds max.



#### **Packaging Dimensions**





## **Gas Discharge Tubes**

CG/CG2 Series



#### Part Numbering System and Ordering Information

### CG2 XXX XX \* XX

Series **CG** – for 75, 90, or 110V CG2 - for 145V to 1000V

#### **Breakdown Voltage**

ounca	01111 10110
75	300
90	350
110	470
145	600
230	800
250	1000

#### Lead Option Code

(Blank) = No Leads / Core L = Straight Leads

LS = Shaped Leads MS = Surface Mount

#### **Option Code\***

SN = may have different DC Breakover Voltage Limit. Please refer to Electrical Characteristics table for additional information.

#### Packaging Option Code -

(Blank) = No Leads / Core, Bulk Bag - 400 pcs L(Blank) = Straight Lead, Tray - 50 pcs LTR = Straight Lead, Tape & Reel per EIA RS-296-E - 500 per reel LS(Blank) = Shaped Lead (see LS dimensions), Tape & Reel - 500 per reel

#### Examples:

CG75 - A non-leaded 75V device

CG2230L -- A leaded 230V device

CG2800LTR - A leaded 800V device, tape-and-reel (per EIA standard RS-296-D)

#### Notes:

CG/CG2 devices with other breakdown voltages in the 75-1000 V range are available upon request.